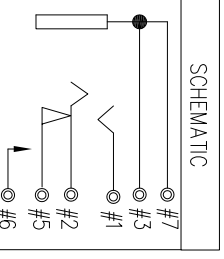
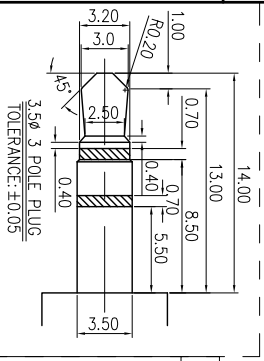


RECOMMENDED P.C.B. LAYOUT T=1.00
TOP VIEW (TOLERANCE: ±0.05)



REV.	ECN NO OR	DESCRIPTION	REVISED	DATE
B	增加MYLAR	ECN NO: C090191	KENSON	2009.10.21
C	ECN NO: C10409-1	Modify Rating specification	BILLY	2011.06.23
D	ECN NO: C40074	Modify LAYOUT	ZLS	2014.8.12

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - RATING: 36V AC, 1A DC.
 - CONTACT RESISTANCE: 50mΩ MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC
- MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.4~3.0 KGf
 - WITHDRAWAL FORCE : 0.3~2.0 KGf
- LIFE TEST: 5,000 CYCLES MIN.
- OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC".
- TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN PRODUCT IDENTIFICATION MARK ON JACK: ©
- HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING:
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- PACKAGING: TAPE&REEL.



I	MYLAR	1	MYLAR 0.075T		
H	SHIELD	1	COPPER ALLOY 0.20T	NI PLATING	
G	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△Gold flash on contact area and solder shield over Nickel Plated	
F	MAKE TERMINAL	1	COPPER ALLOY 0.20T	GOLD FLASH	
E	RING	1	COPPER ALLOY 0.20T	△Gold flash on contact area and solder shield over Nickel Plated	
D	TIP	1	COPPER ALLOY 0.25T	GOLD FLASH	
C	EARTH	1	COPPER ALLOY 0.20T	NI PLATING	
B	METAL	1	COPPER ALLOY	NI PLATING	
A	BODY	1	HIGH TEMP THERMOPLASTIC III 94V-0	LIME(577C)	
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR	
UNLESS OTHERWISE SPECIFIED TOLERANCES					
Singatron Enterprise Co., Ltd. 信音企業股份有限公司					
DECIMALS: ANGLES:					
X : ±0.5 X : ±2°					
X.X : ±0.3 X.X : ±1'					
X.XX : ±0.2					
TITLE: 3.50 PHONE JACK					
DWG: ZLS 14/8/19 PART NO. 2SJ2285-013481					
CHKD: BILLY 14/8/19 SCALE 3:1 UNIT: mm					
APVD: ZLZ 14/8/19 SIZE: A3 SHEET: 10F1 REV: D					
CUSTOMER COPY					